
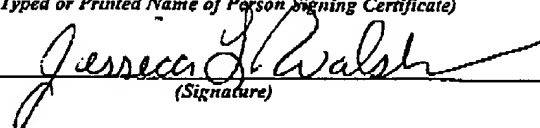


<b>AMENDMENT TRANSMITTAL LETTER (Large Entity)</b>				Docket No. <b>FIS920000372US1</b>	
Applicant(s): <b>S. SUNDAR KUMAR IYER ET AL.</b>					
Serial No. <b>09/878,556</b>	Filing Date <b>09/11/2001</b>	Examiner <b>J. CHEN</b>	Group Art Unit <b>2813</b>		
Invention: <b>METHOD OF FORMING VARIABLE OXIDE THICKNESS ACROSS SEMICONDUCTOR CHIPS</b>					
<u><b>TO THE COMMISSIONER FOR PATENTS:</b></u>					
Transmitted herewith is an amendment in the above-identified application. The fee has been calculated and is transmitted as shown below.					
<b>CLAIMS AS AMENDED</b>					
	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST # PREV. PAID FOR	NUMBER EXTRA CLAIMS PRESENT	RATE	ADDITIONAL FEE
TOTAL CLAIMS	20 -	22 =	0 x	\$18.00	\$0.00
INDEP. CLAIMS	6 -	6 =	0 x	\$84.00	\$0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					\$0.00
<b>TOTAL ADDITIONAL FEE FOR THIS AMENDMENT</b>					<b>\$0.00</b>
<div style="margin-top: 20px;"><input checked="" type="checkbox"/> No additional fee is required for amendment. <input type="checkbox"/> Please charge Deposit Account No. _____ in the amount of _____ <input type="checkbox"/> A check in the amount of _____ to cover the filing fee is enclosed. <input checked="" type="checkbox"/> The Director is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. <b>09-0458</b> <input checked="" type="checkbox"/> Any additional filing fees required under 37 C.F.R. 1.16. <input type="checkbox"/> Any patent application processing fees under 37 CFR 1.17.</div> <div style="margin-top: 20px;"> _____ Signature</div> <div style="margin-top: 10px;">Dated: <b>October 22, 2003</b></div> <div style="margin-top: 10px;"><b>Sean F. Sullivan</b> Reg. No. 38,328 Cantor Colburn LLP 55 Griffin Road South Bloomfield, CT 06002 860-286-2939 Customer Service No. 29371 Confirmation No. 3210</div> <div style="margin-top: 20px; border: 1px solid black; padding: 5px;"><div style="border-bottom: 1px solid black; margin-bottom: 5px;">Signature of Person Mailing Correspondence</div><div style="border-bottom: 1px solid black; margin-bottom: 5px;">Typed or Printed Name of Person Mailing Correspondence</div></div> <div style="margin-top: 10px;">cc:</div>					

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<b>CERTIFICATE OF TRANSMISSION BY FACSIMILE (37 CFR 1.8)</b>			Docket No.	
Applicant(s): S. SUNDAR KUMAR IYER ET AL.			FIS920000372US1	
Serial No. 09/878,556	Filing Date 06/11/2001	Examiner J. CHEN	Group Art Unit 2813	
Invention: <b>METHOD FOR FORMING VARIABLE OXIDE THICKNESS ACROSS SEMICONDUCTOR CHIPS</b>				
<p>I hereby certify that this <u>Transmittal and Amendment</u> (Identify type of correspondence)</p> <p>is being facsimile transmitted to the United States Patent and Trademark Office (Fax. No. <u>703-872-9318</u>)</p> <p>on <u>October 22, 2003</u> (Date)</p> <p style="text-align: right;">Jessica L. Walsh (Typed or Printed Name of Person Signing Certificate)</p> <p style="text-align: right;"> (Signature)</p> <p style="text-align: center;">Note: Each paper must have its own certificate of mailing.</p> <p style="text-align: right;"><b>RECEIVED CENTRAL FAX CENTER OCT 22 2003</b></p> <p style="text-align: right;"><b>OFFICIAL</b></p>				

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: S. SUNDAR KUMAR IYER, ET AL. )  
Serial No.: 09/878,556 ) Group Art Unit: 2813  
Filed: June 11, 2001 ) Examiner: Chen, J.  
For: METHOD OF FORMING VARIABLE )  
OXIDE THICKNESS ACROSS ) Confirmation No.: 3210  
SEMICONDUCTOR CHIPS )

#9/c  
Arndt  
J. McInnis  
10/28/03

AMENDMENT AND RESPONSE TO RESTRICTION REQUIREMENTS

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

In response to the Office Action mailed September 24, 2003, please amend the  
Application as follows: